

Low VF Glass Passivated Bridge Rectifiers

Reverse Voltage - 600 Volts Forward Current - 6.0 Amperes

Features

- Glass passivated chip
- Low forward voltage drop
- Ideal for printed circuit board
- High surge current capability
- •Meet UL flammability classification 94V-0

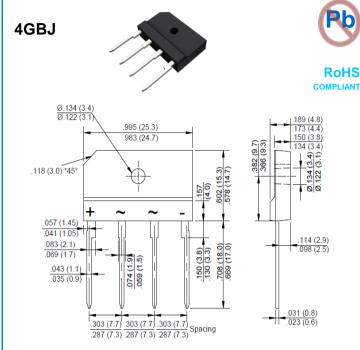
Mechanical Data

- Polarity: Symbol marked on body
- Mounting position: Any

Note: Products with logo are made by HY Electronic (Cayman) Limited.

Applications

 General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.



Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

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Characteristics	Symbol	4GBJ606U	Unit
Maximum Repetitive Peak Reverse Voltage	VRRM	600	V
Maximum RMS Voltage	VRMS	420	V
Maximum DC Blocking Voltage	VDC	600	V
Maximum Average Forward (with heatsink Note 2)	lano	6.0	Α
Rectified Current @ Tc=100°C (without heatsink)	l(AV)	2.8	
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,	Isou	170	А
Superimposed on Rated Load (JEDEC Method)	IFSM		
I ² t Rating for Fusing (t<8.3mS)	l ² t	120	A ² s
Peak Forward Voltage per Diode at 3A DC	VF	0.9	V
Maximum DC Reverse Current at Rated @TJ=25°C	lr	5.0	μА
DC Bolcking Voltage per Diode @TJ=125℃	IR	120	
Typical Junction Capacitance per Diode (Note1)	Cı	55	pF
Typical Thermal Resistance to case (with heatsink (Note2))	Rejc	1.8	°C/W
Operating Junction Temperature Range	TJ	-55 to +150	$^{\circ}$
Storage Temperature Range	Тѕтс	-55 to +150	$^{\circ}$

Notes: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

- 2.Device mounted on 75mm*75mm*1.6mm Cu plate heatsink.
- 3. The typical data above is for reference only .

4GBJ606F-U-00-S003 Rev. 11, 18-May-2020



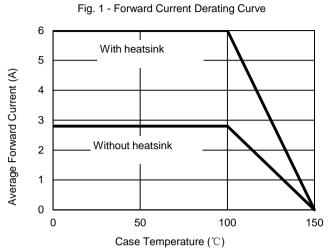


Fig. 2 - Maximum Non-Repetitive Surge Current 180 160 Peak Forward Surge Current (A) 140 120 100 80 60 40 20

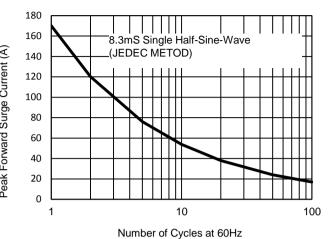
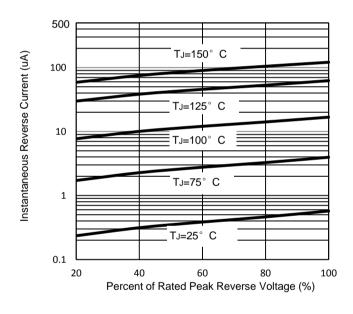


Fig. 3 - Typical Reverse Characteristics





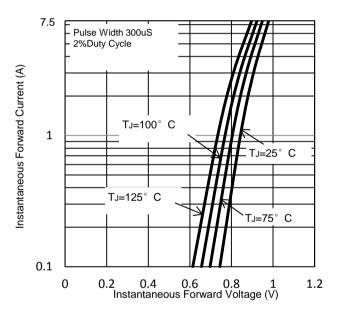
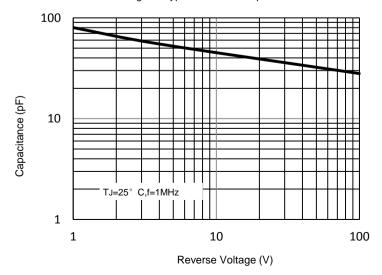


Fig. 5 - Typical Junction Capacitance



The curve above is for reference only.

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